

UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.uspto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/680,260	10/08/2003	David William Abraham	YOR920030013US1	5657
	7590 01/03/200 ELLECTUAL PROPEI	7 RTY LAW GROUP, PLLC	EXAMINER	
8321 OLD COU	JRTHOUSE ROAD	,	MAI, ANḤ D	
SUITE 200 VIENNA, VA 22182-3817			ART UNIT	PAPER NUMBER
· == · · · · · · · · · · · · · · · · ·			2814	
SHORTENED STATUTORY	Y PERIOD OF RESPONSE	MAIL DATE	DELIVERY MODE	
3 MO	NTHS	01/03/2007	PAPER	

Please find below and/or attached an Office communication concerning this application or proceeding.

If NO period for reply is specified above, the maximum statutory period will apply and will expire 6 MONTHS from the mailing date of this communication.

Office Action Summary Examiner Art Unit 2814 The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication. - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any		Application No.	Applicant(s)				
- The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication. - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any		10/680,260	ABRAHAM ET AL.				
The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication. - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any	Office Action Summary	Examiner	Art Unit				
Period for Reply A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication. - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any	·	*	= - · · ·				
A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication. - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any		tion appears on the cover sheet w	with the correspondence address	s			
 WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION. Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication. If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication. Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any 	• •	DEDIVIO SET TO EVOIDE 3 A	MONITURE OF THIRTY (30) D	Δ V S			
earned patent term adjustment. See or or the term of the	WHICHEVER IS LONGER, FROM THE MAIL - Extensions of time may be available under the provisions of 37 after SIX (6) MONTHS from the mailing date of this communic - If NO period for reply is specified above, the maximum statutor - Failure to reply within the set or extended period for reply will.	LING DATE OF THIS COMMUN 7 CFR 1.136(a). In no event, however, may a ation. hy period will apply and will expire SIX (6) MO by statute, cause the application to become A	ICATION. reply be timely filed NTHS from the mailing date of this commur NBANDONED (35 U.S.C. § 133).				
Status	Status						
1)⊠ Responsive to communication(s) filed on <u>03 October 2006</u> .	1)⊠ Responsive to communication(s) filed o	on <u>03 October 2006</u> .					
2a) This action is FINAL. 2b) ☐ This action is non-final.	2a) This action is FINAL. 2b)	<u> </u>					
closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.	closed in accordance with the practice	under <i>Ex parte Quayle</i> , 1935 C.	D. 11, 453 O.G. 213.				
Disposition of Claims	Disposition of Claims						
4)⊠ Claim(s) <u>1,2,5-23,25 and 26</u> is/are pending in the application.							
4a) Of the above claim(s) is/are withdrawn from consideration.							
5) Claim(s) is/are allowed.	5) Claim(s) is/are allowed.						
6)⊠ Claim(s) <u>1,2,5-23,25 and 26</u> is/are rejected.	•	cted.		•			
7) Claim(s) is/are objected to.							
8) Claim(s) are subject to restriction and/or election requirement.							
Application Papers	Application Papers		÷ .				
9) The specification is objected to by the Examiner.			·				
10) The drawing(s) filed on is/are: a) accepted or b) objected to by the Examiner.							
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).							
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).							
11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.	11) I he oath or declaration is objected to by	y the Examiner. Note the attach	ed Office Action of form F 10-1	JZ.			
Priority under 35 U.S.C. § 119	•						
12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).	-	foreign priority under 35 U.S.C.	§ 119(a)-(d) or (f).				
a) ☐ All b) ☐ Some * c) ☐ None of:							
1. Certified copies of the priority documents have been received.							
 2. Certified copies of the priority documents have been received in Application No. 3. Copies of the certified copies of the priority documents have been received in this National Stage 							
application from the International Bureau (PCT Rule 17.2(a)).							
* See the attached detailed Office action for a list of the certified copies not received.							
Attachment(e)	Attachmont/e\						
Attachment(s) 1) Notice of References Cited (PTO-892) 4) Interview Summary (PTO-413)		4) Interview	v Summary (PTO-413)				
2) Notice of Draftsperson's Patent Drawing Review (PTO-948)	2) Notice of Draftsperson's Patent Drawing Review (PTO-948)						
3) Information Disclosure Statement(s) (PTO/SB/08) Paper No(s)/Mail Date 5) Notice of Informal Patent Application 6) Other:							

Art Unit: 2814

DETAILED ACTION

Status of the Claims

1. Amendment filed July 10, 2006 has been entered. Claims 3 and 4 have been cancelled. Claims 1, 6, 7, 15-20, 22, 24 and 25 have been amended. Claims 1, 2 and 5-26 are pending.

Continued Examination Under 37 CFR 1.114

2. A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on October 3, 2006 has been entered.

Claim Objections

3. Claim 13 is objected to under 37 CFR 1.75(c), as being of improper dependent form for failing to further limit the subject matter of a previous claim. Applicant is required to cancel the claim(s), or amend the claim(s) to place the claim(s) in proper dependent form, or rewrite the claim(s) in independent form.

Claim 13 recites: <u>further</u> comprising producing a magnetic device.

Since the "producing a magnetic device" of claim 13 does not include any elements that narrows the device already formed by claim 1, claim 13, thus, <u>fails to further limit claim 1</u>.

Applicant still fails to distinguish the magnetic film formed by claim 1 and the so called magnetic "device" of claim 13.

This is a repeated objection.

Art Unit: 2814

Claim Rejections - 35 USC § 112

The following is a quotation of the first paragraph of 35 U.S.C. 112:

The specification shall contain a written description of the invention, and of the manner and process of making and using it, in such full, clear, concise, and exact terms as to enable any person skilled in the art to which it pertains, or with which it is most nearly connected, to make and use the same and shall set forth the best mode contemplated by the inventor of carrying out his invention.

4. Claims 1, 2, 5-23, 25 and 26 are rejected under 35 U.S.C. 112, first paragraph, as failing to comply with the written description requirement. The claim(s) contains subject matter which was not described in the specification in such a way as to reasonably convey to one skilled in the relevant art that the inventor(s), at the time the application was filed, had possession of the claimed invention.

There does not appear to be a written description of the claim limitation "wherein said reactive plasma includes O₂ and a fluorine-containing gas" in the application as filed.

In the context of cancelled claim 24, the two gases "O₂ and fluorine-containing gas" are in a Markush group. Since the specification only provide support for plasma fluorine-containing gas to form an insulating pattern.

According to the Remarks, O₂ and fluorine-containing gas are intended to be used as a combination.

However, the specification fails to support that assertion.

How, when and where does the magnetic thin film pattern being exposed to O_2 ?

Therefore, the "reactive plasma includes both O₂ and fluorine-containing gas" is new matter.

Applicant must cancel the new matter in response to this office action.

Art Unit: 2814

5. Claims 1, 2, 5-23, 25 and 26 are rejected under 35 U.S.C. 112, first paragraph, as failing to comply with the enablement requirement. The claim(s) contains subject matter which was not described in the specification in such a way as to enable one skilled in the art to which it pertains, or with which it is most nearly connected, to make and/or use the invention.

Amended claim 1, line 5 recites: wherein said reactive plasma includes O₂ and a fluorine-containing gas.

However, the specification fails to enable one skilled in the art to make the invention, since only fluorine-containing gas is shown.

The following is a quotation of the second paragraph of 35 U.S.C. 112:

The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.

6. Claim 13 is rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention.

Claim 13, recites: the method of claim 1, further comprising producing a magnetic device.

What is the magnetic device?

Is the device produced by claim 1 not a magnetic device?

What is the difference between the magnetic device produced by claim 1 and that of claim 13?

What is the process step of "producing a magnetic device"?

Art Unit: 2814

Claim 13 recites "further comprising: producing a magnetic device" but without providing any other process steps that already recited in claim 1, thus, claim 13 is indefinite.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

7. Claims 1, 2, 5-11, 13-15, 17, 19, 22, 23, 25 and 26 are rejected under 35 U.S.C. 102(b) as being anticipated by Kamata et al. (U.S. Pub. No. 2002/0142192) of record.

With respect to claim 1, Kamata teaches method of patterning a magnetic thin film as claimed including:

transforming a portion of the magnetic thin film (20, 330, 350) to be non-magnetic and electrically insulating (40, 370) using a chemical transformation, the chemical transformation comprises using a fluorine-based reactive plasma,

wherein the reactive plasma includes O₂ and a fluorine-containing gas. (See Figs. 3A-B, 13A-B).

With respect to claim 2, the method of Kamata further includes: providing a mask (30, 360) over the portion of the magnetic thin film (20) to be preserved using photolithography.

With respect to claim 5, the fluorine-based reactive plasma of Kamata CF₄, SF₆, CHF₃.

Art Unit: 2814

With respect to claim 6, the pressure used in the converting of Kamata is within a range of about 10 mT to about 30 mT.

With respect to claim 7, the portion of the magnetic thin film (20) of Kamata comprises of alloys of nickel, iron, and cobalt, and the converting comprising converting the alloys of nickel, iron, and cobalt, to a fluorine-containing film.

With respect to claim 8, the fluorine-containing film (40) is non-ferromagnetic.

With respect to claim 9, the fluorine-containing film (40) of Kamata is non-magnetic.

With respect to claim 10, the fluorine-containing film (40) of Kamata is electrically insulating.

With respect to claim 11, the mask (30) of Kamata comprises a photoresist.

With respect to claim 13, the method of Kamata further includes: producing a magnetic device.

With respect to claim 14, the using chemical transformation of Kamata can be performed at room temperature.

With respect to claim 15, the reactive plasma of Kamata includes a fluorocarbon.

With respect to claim 17, the reactive plasma of Kamata includes sulfur hexafluoride.

With respect to claim 19, the pressure of Kamata is selectively employed for the plasma sputtering such that the magnetic thin film material (20) is substantially free of erosion.

With respect to claim 22, the mask of Kamata comprises an insulating hard mask (360), the method of Kamata further includes: after the converting, selectively etching the insulating hard mask (360) to pattern the insulating hard mask.

Art Unit: 2814

With respect to claim 23, the method of Kamata further includes: forming a conductive material (380) over the area where the insulating hard mask (360) was etched.

With respect to claim 25, the magnetic thin film (20) of Kamata includes a magnetic tunnel junction (MTJ), and wherein after the converting portion, the edges of the magnetic tunnel junction have no exposure to oxygen. (see Figs 13).

With respect to claim 26, the edge smoothness of the MTJ of Kamata is inherently determined by a line edge roughness of the mask (360).

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

8. Claim 12 is rejected under 35 U.S.C. 103(a) as being unpatentable over Kamata '192 as applied to claim 2 above, and further in view of Ning et al. (U.S. Pub. No. 2002/0098676) of record.

With respect to claim 12, Kamata teaches providing a mask over a portion of the magnetic thin film for patterning.

Thus, Kamata is shown to teach all the features of the claim with the exception of utilizing a metal hard mask.

However, Ning teaches utilizing photolithography to provide a mask including TaN, TiN (244) for patterning.

Art Unit: 2814

Therefore, it would have been obvious to one having ordinary skill in the art at the time of invention to provide a hard mask of Kamata including a TiN and TaN as taught by Ning for patterning over the portion of the magnetic thin film.

9. Claim 16 is rejected under 35 U.S.C. 103(a) as being unpatentable over Kamata as applied to claim 1 above, and further in view of Baglin et al. (U.S. Patent No. 6,331,364) of record.

Kamata teaches converting a portion of a magnetic thin film by a reactive plasma.

Thus, Kamata is shown to teach all the features of the claim with the exception of using argon for the reactive plasma.

However, Baglin teaches other ion species that may be used to converting a magnetic thin film including argon. (See col. 10, lines 9-13).

Therefore, it would have been obvious to one having ordinary skill in the art at the time of invention was made to convert a portion of the magnetic thin film of Kamata utilizing argon plasma as taught by Baglin to achieve the desired chemical conversion.

10. Claim 18 is rejected under 35 U.S.C. 103(a) as being unpatentable over Kamata '192.

Kamata teaches converting a potion of the magnetic thin film (20) into non-magnetic insulating (40).

Thus, Kamata is shown to teach all the features of the claim with the exception of explicitly to include bromide.

Art Unit: 2814

However, Kamata teaches the reactive gas containing halide. It is well known that bromide in a member of halide gas.

Therefore, it would have been obvious to one having ordinary skill in the art at the time of invention to converting a portion of the magnetic thin film of Kamata utilizing bromide, since bromide as well as iodide, fluoride or chloride are member of reactive gas known as halide.

11. Claims 20 and 21 are rejected under 35 U.S.C. 103(a) as being unpatentable over Kamata '192 as applied to claim 1 above, and further in view of Chen et al. (U.S. Patent No. 6,165,803) of record.

With respect to claim 20, Kamata teaches converting a portion of magnetic thin film (20) by reactive plasma.

Thus, Kamata is shown to teach all the features of the claim with the exception of further process step.

However, Chen teaches process steps following the conversion including:

forming an insulating layer (72) over the converted portion (42b) of the magnetic thin film (42) and the mask (52); and

etching the insulating layer (72) and the mask (52) to planarize the upper level of the mask (52) and the insulating layer (72). (See Fig. 12).

Therefore, it would have been obvious to one having ordinary skill in the art at the time of invention was made to further process the converted magnetic thin film of Kamata utilizing the further process step as taught by Chen to form the MTJ device.

Art Unit: 2814

With respect to claim 21, the method of Chen, further includes:

selectively etching the mask (52); and forming a conductive material (70) over the insulating layer (72) and the area where the mask (52) was selectively etched. (See Fig. 13).

Response to Arguments

12. Applicant's arguments filed July 10, 2006 have been fully considered but they are not persuasive.

Claimed Invention:

The term "wherein the reactive plasma includes O₂ and fluorine-containing gas" are lacking both enablement requirement and written support, as discussed above.

Formal Matter:

The limitation "further comprising producing a magnetic device", clearly fails to further limit claim 1 as discussed above.

The objection is maintained and repeated.

Indefiniteness Rejection:

Applicant fails to show the difference between the magnetic film of claim 1 and the magnetic device of claim 13.

The rejection is maintained and repeated.

Rejection under 35 U.S.C. 102(b) and 103(a):

Kamata clearly teaches the magnetic thin film being exposed to reactive plasma includes fluorine-containing gas and oxygen gas. (See at least [0070] and [0181]).

Furthermore, the specification fails to provide support for the reactive plasma includes both O₂ and fluorine-containing gas.

The only concurrent of oxygen plasma being used alone is in the admitted prior art page 2.

Since Kamata teaches all limitation of claim 1, then the combination of Kamata and Ning '676 or Baglin '364 or Chen '803 clearly renders claims 12, 16, 18, 20 and 21 obvious.

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Anh D. Mai whose telephone number is (571) 272-1710. The examiner can normally be reached on 8:00AM-5:00PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Wael Fahmy can be reached on (571) 272-1705. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

anh D. Wai Faminet Examinet